

# **SPECIFICATION**

Part No. : **DSGP.1575.12.4.A.02** 

Description : GPS L1 / GALILEO E1 1575MHz 12\*12\*4mm

Ceramic Patch SMT Antenna

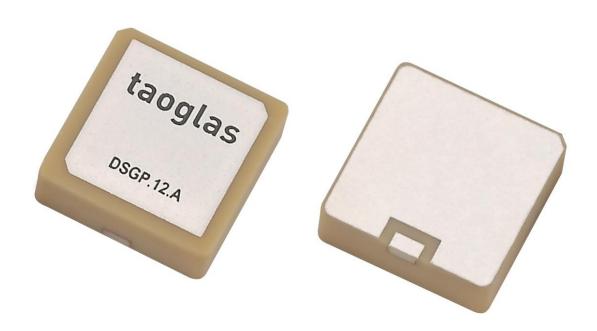
Features : 2.73 dBi Peak Gain for GPS/GALILEO Band

Dims: 12\*12\*4mm

SMT Direct Mount Ceramic Patch Antenna

Automotive TS16949 Approved

RoHS compliant





#### 1. Introduction

The DSGP.1575.12.4.A.02 is a ceramic GPS L1 / GALILEO E1 passive patch antenna. 12mm square and with a height of just 4mm, this antenna is perfect for applications in compact telematics devices, vehicle tracking/fleet management systems, wearables and navigation devices.

The antenna has been tuned on a 50\*50mm ground plane, working at 1575.42MHz with a 2.73dBi gain. The ceramic patch is mounted via SMT process, suitable for high volume low cost assembly.

The antenna is manufactured and tested in a TS16949 first tier automotive approved facility.

Small antennas should ideally be custom tuned for the device environment, Taoglas offers this service subject to NRE and MOQ. For more details please contact your regional Taoglas sales office.



# 2. Specification

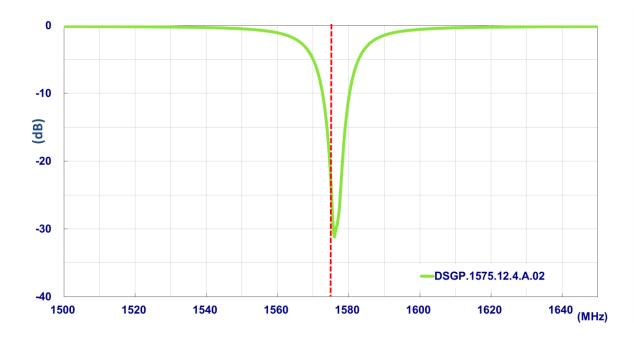
ELECTRICAL		
Application Bands	GPS/GALILEO	
Operation Frequency	1575.42 ±1.023MHz	
Return Loss	< -10dB @ Center Frequency	
Gain at Zenith	2.73dBi	
Efficiency	62.36%	
Impedance	50 ohms	
MECHANICAL		
Ceramic Dimension	12*12*4mm	
Weight	3.3g	
ENVIRONMENTAL		
Operation Temperature	-40°C to 85°C	
Humidity	Non-condensing 65°C 95% RH	

<sup>\*</sup> Antenna properties were measured with the antenna mounted on 50\*50mm Ground Plane Taoglas Part # DSGPD.12A

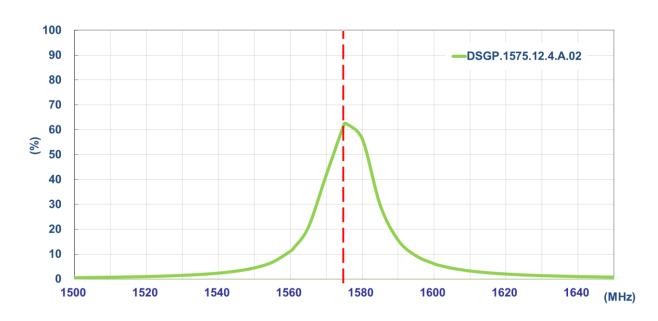


## 3. Antenna Characteristics

#### 3.1. Return Loss

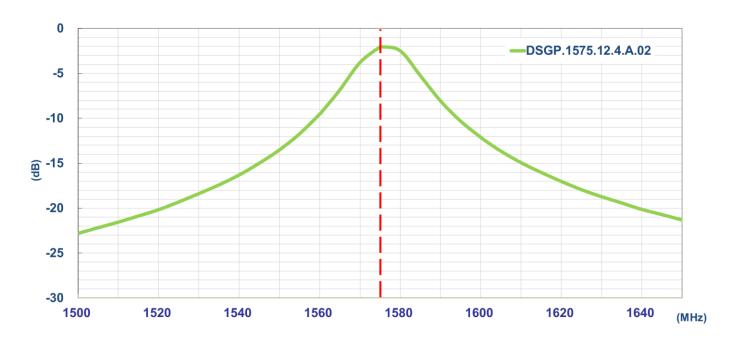


# 3.2. Efficiency

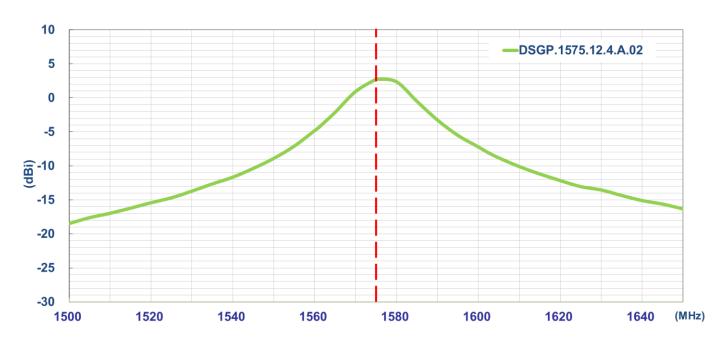




## 3.3. Average Gain



#### 3.4. Peak Gain

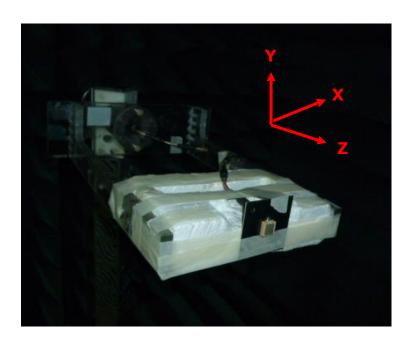




## 4. Antenna Radiation Pattern

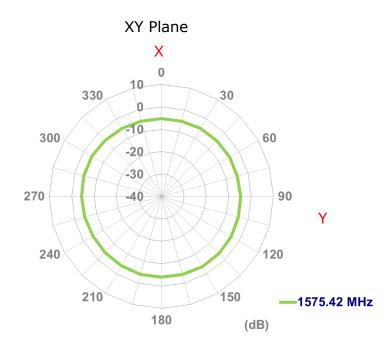
## 4.1. Measurement Setup

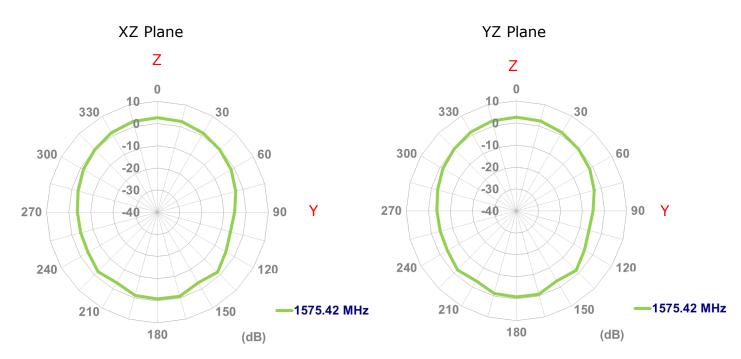
The DSGP.1575.12.4 antenna is tested with 50\*50mm ground plane in a CTIA certified ETS-Lindgren Anechoic Chamber. The test setup is shown below.





#### 4.2. 2D Radiation Pattern

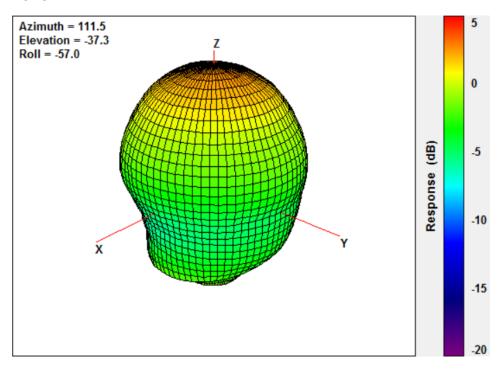






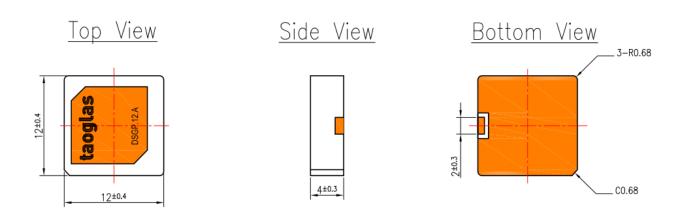
#### 4.3. 3D Radiation Pattern

1575.42MHz



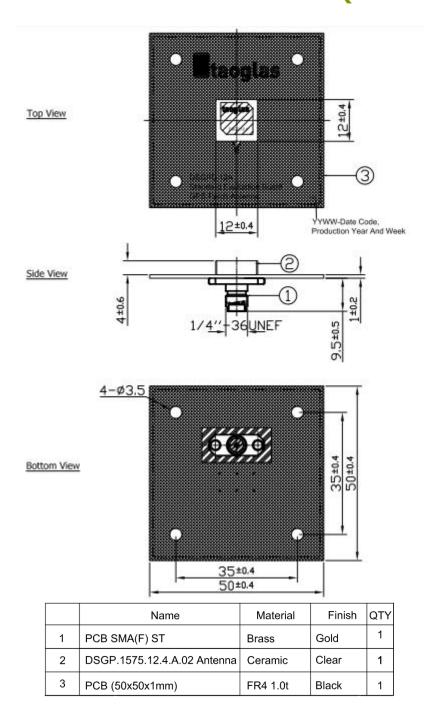


# 5. Mechanical Drawing (Unit: mm)





# 6. Evaluation Board DSGPD.12A (Unit: mm)

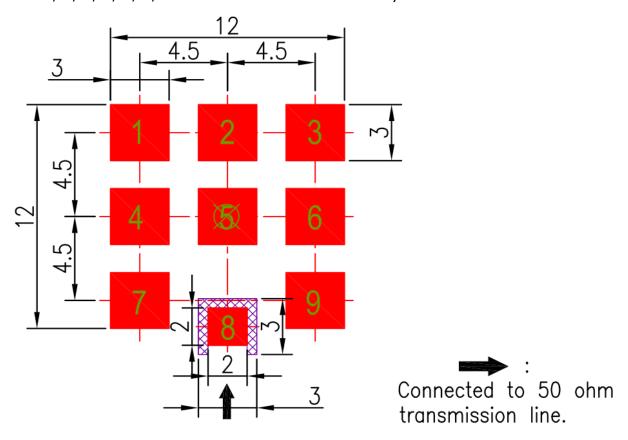




# 7. PCB Footprint Recommendation

#### 7.1. Footprint Copper Keepout Area (Unit: mm)

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size. They should be connected to GND

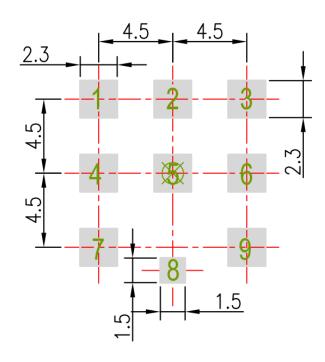


- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout Area
- 6. Copper keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 8. The dimension tolerances should follow standard PCB manufacturing quidelines



#### 7.2. Paste Area (Unit: mm)

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size.

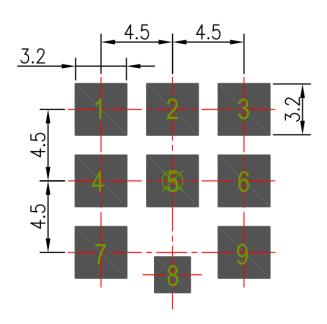


- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
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- 6. Copper keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
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#### 7.3. Top Solder Mask (Unit: mm)

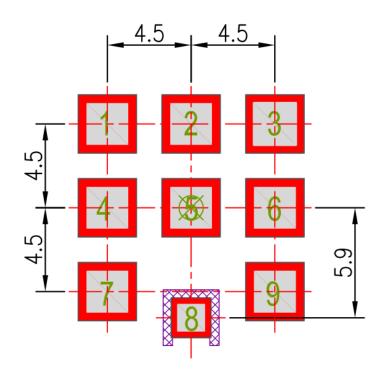
Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size. This drawing is a negative of solder mask. Black regions are anti-mask.



- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout Area
- 6. Copper keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 8. The dimension tolerances should follow standard PCB manufacturing guidelines



## 7.4. Composite Diagram (Unit: mm)



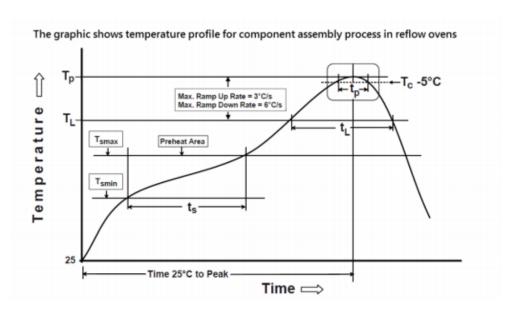
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 6. Copper keepout should extend through all PCB layers.
- 7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 8. The dimension tolerances should follow standard PCB manufacturing quidelines



# 8. Recommended Reflow Soldering Profile

DSGP.12 can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follows:

Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	Temperature Min(Tsmin)	150°C
	Temperature Max(Tsmax)	200°C
	Time(ts) from (Tsmin to Tsmax)	60-120 seconds
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)
REFLOW	.OW Temperature(TL)	217°C
	Total Time above TL (tL)	30-100 seconds
PEAK	Temperature(TP)	260°C
	Time(tp)	2-5 seconds
RAMP-DOWN	Rate	3°C/second(max)
Time from 25°C to Peak Temperature		8 minutes max.
Composition of solder paste		96.5Sn/3Ag/0.5Cu
Solder Paste Model		SHENMAO PF606-P26



Soldering Iron condition: Soldering iron temperature 270°C±10°C.

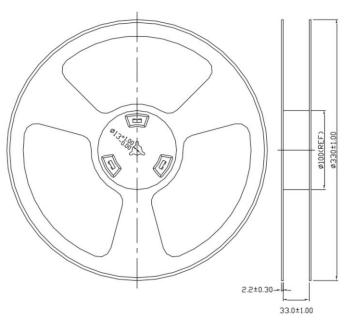
Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.

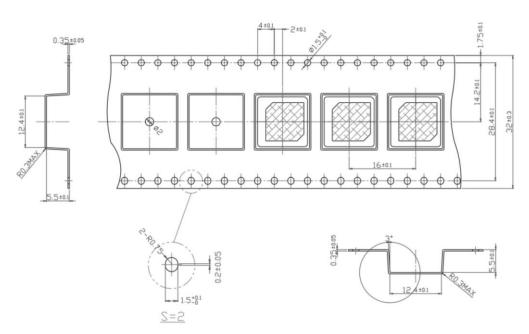


# 9. Packaging

## 9.1. Inner Tray

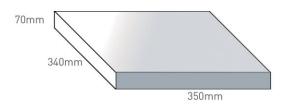
500 pc DSGP.1575.12.4.A.02 per reel Dimensions - Ø335\*40mm Weight - 1.86Kg



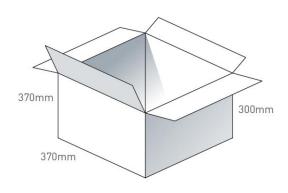




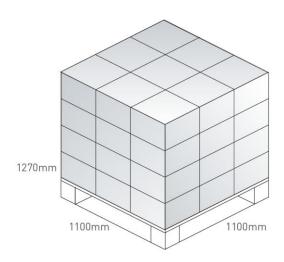
1 pc reel in small inner box Dimensions - 350\*340\*70mm Weight - 2.0Kg



4 Reels / 2000 pcs in one carton Carton Dimensions - 370\*370\*300mm Weight - 7.94Kg



Pallet Dimensions 1100\*1100\*1270mm 36 Cartons per Pallet 9 Cartons per layer 4 Layers



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